

SURFACE MOUNT
GLASS PASSIVATED SILICON RECTIFIER
VOLTAGE RANGE 50 to 1000 Volts CURRENT 1.0 Ampere

FEATURES

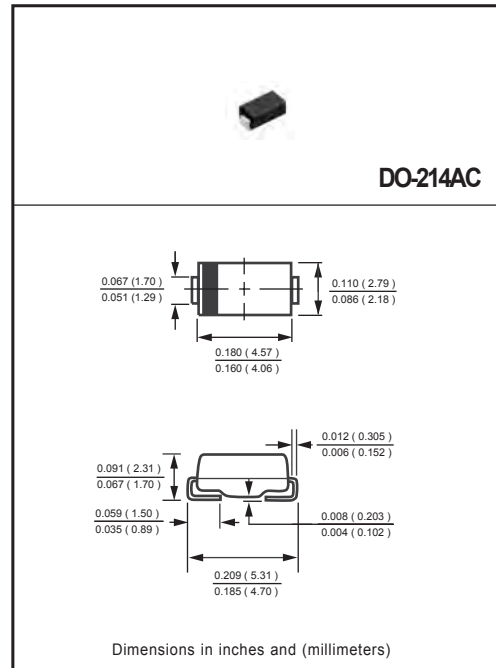
- * Glass passivated device
- * Ideal for surface mounted applications
- * Low leakage current
- * Metallurgically bonded construction
- * Mounting position: Any
- * Weight: 0.057 gram

MECHANICAL DATA

- * Epoxy : Device has UL flammability classification 94V-0

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25 °C ambient temperature unless otherwise specified.
resistive or inductive load.



MAXIMUM RATINGS (@ TA=25 °C unless otherwise noted)

RATINGS	SYMBOL	FM4001	FM4002	FM4003	FM4004	FM4005	FM4006	FM4007	UNITS
Maximum Recurrent Peak Reverse Voltage	V_{RRM}	50	100	200	400	600	800	1000	Volts
Maximum RMS Voltage	V_{RMS}	35	70	140	280	420	560	700	Volts
Maximum DC Blocking Voltage	V_{DC}	50	100	200	400	600	800	1000	Volts
Maximum Average Forward Rectified Current at Ambient Temperature	I_O	1.0							Amps
Peak Forward Surge Current 8.3 ms single half sine-wave superimposed on rated load (JEDEC method)	I_{FSM}	30							Amps
Current Squared Time	I^2t	3.7							A ² /Sec
Typical Thermal Resistance (Note 1)	$R_{\theta JA}$	80							°C/W
Typical Thermal Resistance (Note 1)	$R_{\theta JL}$	27					30		°C/W
Typical Junction Capacitance (Note 2)	C_J	15							pF
Operating Temperature Range	T_J	150							°C
Storage Temperature Range	T_{STG}	-55 to + 150							°C

ELECTRICAL CHARACTERISTICS (@TA=25 °C unless otherwise noted)

CHARACTERISTICS	SYMBOL	FM4001	FM4002	FM4003	FM4004	FM4005	FM4006	FM4007	UNITS
Maximum Instantaneous Forward Voltage at 1.0A DC	V_F	1.0							Volts
Maximum Average Reverse Current at Rated DC Blocking Voltage	I_R	5.0							μA
		30							μA

- NOTES : 1. Thermal Resistance :Mounted on PCB.
2. MEASURED at 1 MHz and applied reverse voltage of 4.0 volts.
3. "Fully ROHS compliant", "100% Sn plating (Pb-free)".

RATING AND CHARACTERISTICS CURVES (FM400x - W - A01)

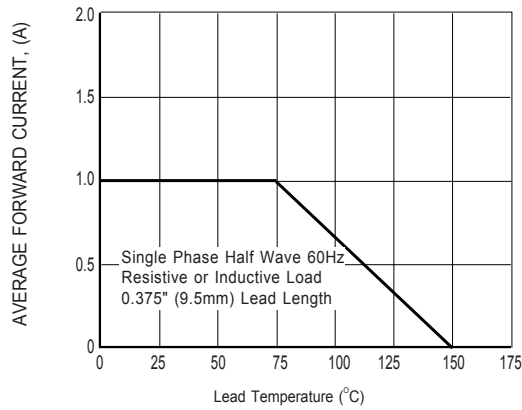


FIG.1 TYPICAL FORWARD CURRENT DERATING CURVE

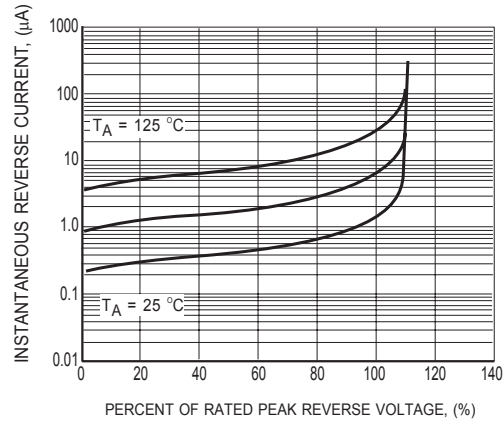


FIG.2 TYPICAL REVERSE CHARACTERISTICS

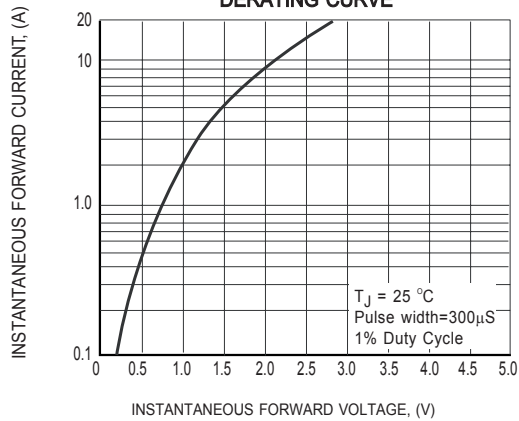


FIG.3 TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

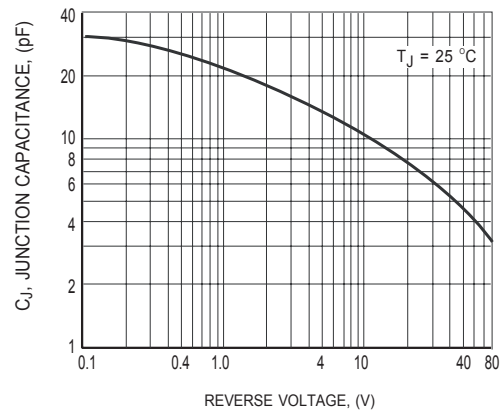


FIG.4 TYPICAL JUNCTION CAPACITANCE

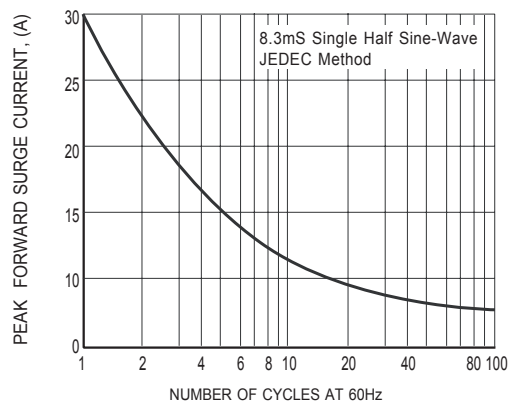
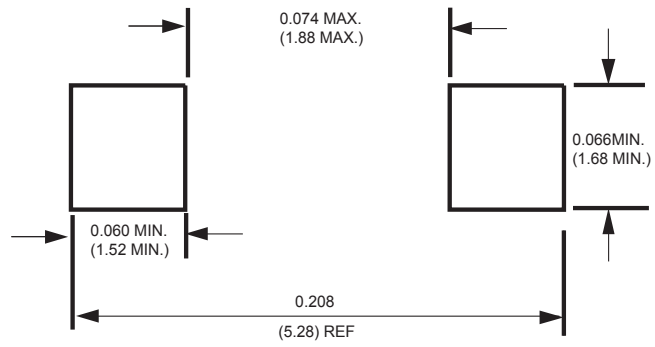


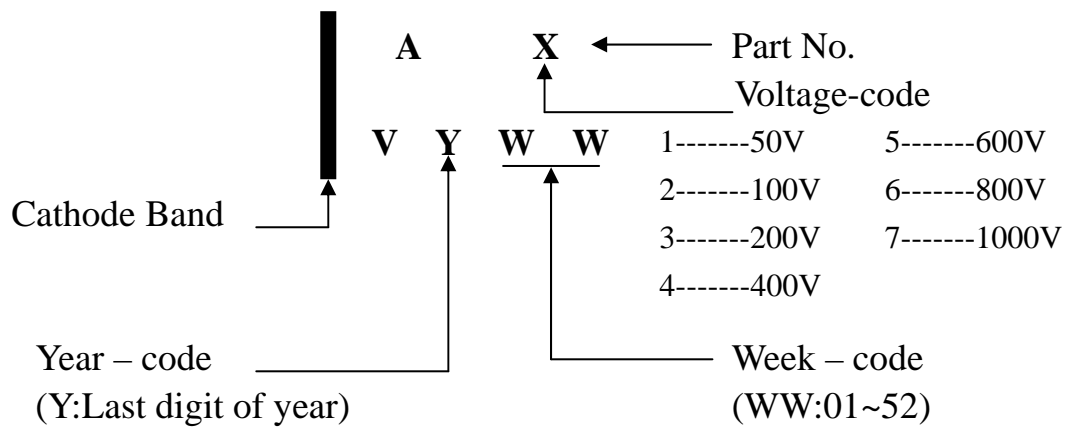
FIG.5 MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

Mounting Pad Layout



Dimensions in inches and (millimeters)

Marking Description



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